| REPORT DOCUMENTATION PAGE   |   |  | AFRL-SR-BL-TR-98-          |  |  |
|---|---|--|----------------------------|--|--|
| Public reporting burden for this collection of informatic<br>the data needed, and completing and reviewing this of<br>reducing this burden to Washington Headquarters Se  | on is estimated to average 1 hour per response,<br>ollection of information. Send comments regar<br>rivices, Directorate for Information Operations a | including the time for reviewing in<br>ding this burden estimate or any ot<br>nd Reports, 1215 Jefferson Datis | . 0                        | 637  |  |
| Management and Budget, Paperwork Reduction Proj<br>1. AGENCY USE ONLY (Leave  | ect (0704-0188), Washington, DC 20503   | 3. REPORT TYPE AND<br>Final Report   | DATES COVER                | ED   |  |
| blank)  | 0/2//50   |  | 5. FUNDING N               | UMBERS   |  |
| Chemical Physics of Digital Etching   |   |  | F496209410075              |  |  |
|   |   |  | 2303/BS                    |  |  |
| 6. AUTHOR(S)  |   |  | (01)02F                    |  |  |
| Andrew C. Kummel  |   |  | 01100                      |  |  |
| 7. PERFORMING ORGANIZATION NAME(S) AND ADDRESS(ES)  |   |  | 8. PERFORMING ORGANIZATION |  |  |
| Dept. Chemistry-0358<br>University of California, San Diego<br>9500 Gilman Drive<br>La Jolla, CA 92093-0358   |   |  | REPORT NU                  | MBER   |  |
| 9. SPONSORING / MONITORING AGENCY NAME(S) AND ADDRESS(ES) 10.5  |   |  | 10. SPONSOR                | 0. SPONSORING / MONITORING                                     |  |
| AFOSR: Att Major Hugh DeLong<br>Div. Chemistry and Life Sciences<br>110 Duncan Ave, Suite B115<br>Bolling Air Force Base, DC 20332-001  |   |  | AGENCTR                    | EPORT NUMBER   |  |
| 11. SUPPLEMENTARY NOTES   | · · · · · · · · · · · · · · · · · · ·   |  |                            |  |  |
| 12a. DISTRIBUTION / AVAILABILITY STATEMENT  |   |  |                            | 12b. DISTRIBUTION CODE   |  |
| distribution unlimited.   |   |  |                            |  |  |
| 13. ABSTRACT (Maximum 200 Words   | ;)  |  |                            |  |  |
| We have investigated the chemisorption of halogens on semiconductor surfaces in order to<br>develop a better understanding of passivation and etching of these surfaces. We have<br>shown that halogen chemisorption occurs onto both Si(111) and GaAs(100) via both<br>dissociative chemisorption and abstraction. In abstractive chemisorption of a diatomic<br>molecular halogen, one halogen atoms sticks to the surface while the other is ejected back<br>into the gas phase. The abstraction process can be chemically selectivity for one of the two<br>atoms in an interhalogen such as ICI. Furthermore, both abstraction and dissociation can<br>be chemically selective for the Ga atoms on the GaAs(100) surface. The chemisorption of<br>halogens can passivate the surface both chemically and electronically. Passivation occurs<br>when a stable homogeneous monolayer of surface monohalide is formed. For GaAs(100),<br>passivation can unpin the Fermi level; this is a critical step in developing a CMOS<br>technology of GaAs. We are now studying the deposition of insulators on GaAs for use in<br>high speed low power wireless communication and satellite technology with support from<br>DOD. |   |  |                            |  |  |
| 14. SUBJECT TERMS   |   |  |                            | 15. NUMBER OF PAGES  |  |
| Semiconductors, etching, passivation, GaAs, STM,<br>halogens, silicon   |   |  |                            | 16. PRICE CODE   |  |
| 17. SECURITY CLASSIFICATION   | 18. SECURITY CLASSIFICATION<br>OF THIS PAGE   | 19. SECURITY CLASSII<br>OF ABSTRACT  | FICATION                   | 20. LIMITATION OF ABSTRACT                                     |  |
| unclassified  | unclassified  | unclassifie  | d                          | UL   |  |
| NSN 7540-01-280-5500  |   |  | Stal<br>Pres<br>298-1      | ndard Form 298 (Rev. 2-89)<br>cribed by ANSI Std. 239-18<br>02 |  |

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#### FINAL REPORT ON AFOSR GRANT TO ANDREW KUMMEL: "Chemical Physics of Digital Etching",

## (a) Cl<sub>2</sub>, Br<sub>2</sub>, and I<sub>2</sub> Chemisorption on Si(100) 2x1

The two most common forms of dissociative chemisorption on metal surfaces are direct and precursor mediated. We have performed a series of experiments that show that these two mechanisms also can describe the chemisorption of halogens on semiconductors. In direct chemisorption, a molecule dissociates during the gas-surface collision to form adatoms; this process may have an activation barrier. In precursor mediated chemisorption, the molecule first adsorbs/traps into a molecular precursor state prior to dissociation. This precursor state can be a physisorbate or a charged molecular state. Our experiments have shown that for the heavy diatomic halogens (Cl<sub>2</sub>, Br<sub>2</sub>, and I<sub>2</sub>) at incident translational energies greater than 0.1 eV, the sticking probability is independent of the surface temperature and increases with incident translation energy. This indicates that the heavy halogens chemisorb via direct activated chemisorption at high incident translational energy. At low incident energies, the initial sticking probability, S<sub>0</sub>, decreases with increasing surface temperature, and the sticking probability decreases with increasing incident energies between 0.02 eV and 0.06 eV. Therefore, all three heavy diatomic halogens can adsorb via precursor-mediated chemisorption at low incident translational energy<sup>1,2</sup>. We have also done a series of experiments upon the chemisorption mechanisms of Cl<sub>2</sub> on the Ga-rich GaAs(100) c(8x2), As-rich GaAs(100) c(2x8), and stoichiometric GaAs(100) (1x1) surfaces<sup>3</sup>. In addition, we have examined the competition between etching and passivation on these GaAs surfaces by Cl<sub>2</sub> at 300 K<sup>4</sup>. Futher experiments were done on F<sub>2</sub> and O<sub>2</sub> Chemisorption Mechanisms on Si(100) 2x1 and Si(111) 7x7<sup>5,6</sup>.

# (b) STM of Local Adsorbate Structure for Precursor-mediated Versus Direct Chemisorption

As far as we know, we are the only group to have studied the effect of translational energy upon local adsorbate structure using STM. We have developed a unique machine to dose a crystal surface in ultra-high vacuum with a mono-energetic molecular beam and then examine the adsorbate structure with STM. Using this technique, we have identified the role of the chemisorption mechanism in the formation of adsorbate structures for  $F_2$ ,  $Cl_2$ ,  $Br_2$ , ICl, IBr,  $I_2Cl_6$ , and  $O_2^{-7}$  upon Si(111)-7x7 surfaces at 300 K. When Si(111)-7x7 is dosed with 0.05 eV  $Cl_2$  (precursor-mediated chemisorption), the dominant adsorbate structure is SiCl islands. The SiCl islands are hundreds of Angstroms apart at low coverage and nucleate at missing adatom defects. Conversely, for 0.44 eV  $Cl_2$  dosing (direct-activated chemisorption), island formation is not observed, and only single site center-adatom preferred chemisorption is present. It is proposed that island formation results from  $Cl_2$  adsorption via a mobile molecular physisorption state that dissociates at the edges of SiCl islands while the center-adatom preferred reaction results from instantaneous direct-activated chemisorption<sup>8,9</sup>. When the Cl-Si(111) 7x7 surface is heated to 600 °C and partial desorption occurs, the adsorbate structure is independent of adsorption mechanisms because the SiCl forms a 2-D lattice gas prior to second order recombinative desorption as SiCl<sub>2</sub><sup>10</sup>. These island formation studies are important in understanding defect formation in stimulated etching.

# (c) STM of Local Adsorbate Structure for Abstractive Versus Dissociative Chemisorption

Molecular dynamics simulations by Carter *et al*<sup>11-13</sup> have shown that the reaction of  $F_2$  with the Si(100)-(2x1) surface always proceeds in a stepwise fashion; the first step is the chemisorption of one F atom followed by the cleavage of the F-F bond. The escape or adsorption of the second F atom is the difference between abstractive and dissociative chemisorption. We have recorded atomic-resolution STM images of the Si(111)-(7x7) surface after chemisorption of F<sub>2</sub>, Cl<sub>2</sub>, Br<sub>2</sub>, or I<sub>2</sub> molecules with low and high translational energies. These images allow direct observation of how the probability for abstraction varies with incident translational energy in the limit of zero coverage<sup>14,15</sup>. For low F<sub>2</sub> incident translational energies, nearly all chemisorption. We also show that for higher F<sub>2</sub> incident translation energy, many more chemisorption sites are dimers, two nearest neighbor Si-F sites. These dimer sites are formed through dissociative chemisorption. This trend of increased dissociative chemisorption at high energy is also observed for Cl<sub>2</sub> and Br<sub>2</sub> and is in agreement with theoretical models<sup>11</sup>.

The chemically selective dissociation of interhalogens on Si(111)-7x7 has been investigated using supersonic molecular beams, scanning tunneling microscopy (STM), Auger electron spectroscopy (AES), and thermal desorption spectrometry (TDS). Empty-state STM topographic images show two chemisorption channels: 85% abstractive and 15% dissociative chemisorption. The abstractive chemisorption probability for ICl is considerably higher than Br<sub>2</sub> at similar translational energies even though they have very similar bond strengths and lengths. AES measurements of ICl chemisorption on Si(111)-7x7 show that the absolute ratio of iodine to chlorine is 3:1 at low coverage. This was verified by mass-resolved TDS experiments. Despite the much larger exoergicity for the formation of silicon monochloride (Si-Cl) than silicon monoiodide (Si-I), the chlorine atom in an ICl molecule is preferentially ejected from the surface and the iodine atom remains on the substrate in a single abstractive chemisorption event<sup>16</sup>. The high sticking probability and the selective abstraction of iodine suggest that the interaction between the asymmetric p\* antibonding highest occupied molecular orbital (HOMO) on ICl and the silicon dangling bonds on the Si(111)-7x7 orients the ICl molecules into an Si-I-Cl conformation during abstraction.

selectivity in abstractive dissociation on Si(111)-7x7<sup>17,18</sup>.

# (d) HALOGEN PASSIVATION GaAs(100)

One of the more important technological challenges of GaAs device fabrications is deposition of a nearly defect-free insulator on GaAs that can be used as a gate in a transistor. Unfortunately, unlike silicon, when GaAs is oxidized, Ga2O3 is formed along with metallic As. In general, when insulators are deposited from the gas phase, they react with the GaAs to create interfacial defects which prevent the fabrication of a useful device. We are studying how the GaAs(100) surface can be passivated with molecular halogens so that molecular insulators can be deposited without formation of interfacial defects that pin the Fermi level. When the Ga-rich Ga(100)-c(8x2) surface is dosed with molecular halogens, a 1x1 LEED pattern is formed. We have found that this overlayer is chemically passive: it greatly inhibits the absorption of O<sub>2</sub> or H<sub>2</sub>O. Therefore, it has the required chemical properties for deposition of insulators onto GaAs. The second requirement for the interface is electrical passivation. The GaAs(100) surface is pinned midgap. Reactions with halogens remove the dangling bonds and may even remove the dimer row reconstruction. We have tested this hypothesis by measuring the current versus voltage for electron tunneling at the halogen passivated surface with scanning tunneling microscopy. Our initial results look promising, but we need to repeat the experiments with lower defect density samples. The project also includes depositing molecular insulators onto passivated GaAs surfaces and studying the electronic properties in collaboration with Motorola. Motorola is developing gate technology on GaAs for use in their cellular phones and pagers. A low leakage gate technology on GaAs would enable both the logic and microwave devices to be integrated on a single chip that should lower power consumption and increase the bandwidth of wireless communication devices.

Recently, we have continued our investigation of halogen chemistry on GaAs(100) with funding from the NSF-Division of Materials research. We have focused upon chemical selectivity in the chemisorption of halogens on GaAs(100). The As-rich GaAs(001)-(2x4) surface consists of a top layer of As dimers and a second layer of Ga atoms. When high translational energy Br<sub>2</sub> chemisorbs on this surface at low coverage, there is complete, near perfect, chemical selectivity for the second layer substrate atoms compared to the top layer atoms. Our STM images show that Br<sub>2</sub> molecules react exclusively with the second layer Ga atoms instead of the first layer As atoms. A simple molecular orbital model shows that the Ga atoms are more reactive than the As atoms because the Ga atoms have empty dangling bonds while the As atoms have filled dangling bonds<sup>19</sup>. The bonding of the halogens to the second layer Ga atoms react to form AsBr<sub>2</sub> adsorbates<sup>20</sup>. The Ga-rich GaAs(001)-c(8x2) surface has a top layer of Ga atoms. Our STM studies have shown that on this surface there is near perfect selectivity for halogen reaction with the Ga atoms. Again, a simple molecular orbital model predicts that the Ga atoms show that on this surface there is near perfect selectivity for halogen reaction with the Ga atoms. Again, a simple molecular orbital model predicts that the Ga atoms have empty dangling bonds<sup>21</sup>.

#### (e) DIGITAL ETCHING

We have done a series of experiments upon digital etching of both GaAs(100) and Si(100). Digital etching of GaAs(100) can be implemented with thermal desorption. When the Ga-rich surface GaAs(100)-c(8x2) is dosed with  $Cl_2$ , the adsorption is self limiting and a monolayer of Ga-Cl is formed. Heating the surface removes the GaCl layer and the surface reconstructs to the As-rich GaAs(100)-c(2x8) surface. If this As-rich surface is heated, the surface monolayer of As is desorbed and the Ga-rich surface GaAs(100)-c(8x2) is formed. By repeating this process an

integral number of layers can be etched from the surface, digital etching. We have invested thermal digital etching as well as laser induced and ion stimulated digital etching. However, as explained to us by our industrial collaborators, the application of halogen-GaAs(100) chemistry to passivation and gate deposition is much more important technologically than digital etching. Therefore, we have refocused our halogen surface chemistry applied research upon chemical and electronic passivation for the deposition of gate insulators on GaAs(100). This research is described in a previous paragraph. 1 D. J. D. Sullivan, H. C. Flaum, and A. C. Kummel, Precursor and direct activated chemisorption of chlorine molecules onto Si(111) 7x7 and Si(100) 2x1 surfaces; J. Phys. Chem. 97, 12051 (1993).

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# (f) PAPERS AND STUDENT/POST-DOCS SUPPORTED UNDER PREVIOUS AFOSR GRANTS

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- 15. Y. Liu, A. J. Komrowski, and A. C. Kummel, "Br<sub>2</sub> Etching Dynamics on the As-rich GaAs(001)-(2x4) Surface", (in prep).

### Current and Former Doctoral Research Students Supported Under AFOSR:

## Current and Former Post-Doctoral Associates Supported Under Previous AFOSR

| Grant:       |   |
|--------------|---|
| Temer Ahmadi | (Pd.D., Univ. Cal. Los Angeles with Prof. Mostafa El-Sayed) |
| James McLean | (Ph.D., Cornell University with Prof. Barbara Cooper)       |
| Yong Liu     | (Ph.D., Southampton University with Prof. Neville Jonathan) |